



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

TOYOSAWA et al

Atty. Ref.: 1035-270

Serial No. 09/598,169

Group: 2811

Filed: June 21, 2000

Examiner: Vu, H.

For: A SEMICONDUCTOR DEVICE HAVING ACTIVE
ELEMENT CONNECTED TO AN ELECTRODE
METAL PAD VIA A BARRIER METAL LAYER
AND INTERLAYER INSULATING FILM

* * * * *

February 6, 2002

Assistant Commissioner for Patents
Washington, DC 20231

Sir:

SUPPLEMENTAL AMENDMENT

In further response to the Official Action dated October 4, 2001 (a response to which was filed February 4, 2002), please further amend the above-identified application as follows:

IN THE CLAIMS

Please substitute the following amended claim 25 for corresponding claim 25 previously presented. A copy of the amended claim 25 showing current revisions is attached.

25. (Three Times Amended) A semiconductor device, comprising:

C¹
Sub
D¹

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Suppl
Amdt C
FJONES
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